

S-576Z R Series

Applications

EXTENDED OPERATION TEMPERATURE RANGE. HIGH-WITHSTAND VOLTAGE, HIGH-SPEED, ZCL[™] HALL EFFECT IC

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Rev.1.0 00

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This IC, developed by CMOS technology, is a high-accuracy Hall effect IC that operates with high-withstand voltage over a wide operation temperature range.

The IC switches output voltage level when the IC detects magnetic flux density (magnetic field) polarity changes. The ZCL (Zero Crossing Latch) detection method realizes polarity changes detection with the higher accuracy than the conventional bipolar latch method. Using this IC with a magnet makes it possible to detect the rotation status in various devices.

ABLIC Inc. offers a "magnetic simulation service" that provides the ideal combination of magnets and our Hall effect ICs for customer systems. Our magnetic simulation service will reduce prototype production, development period and development costs. In addition, it will contribute to optimization of parts to realize high cost performance. For more information regarding our magnetic simulation service, contact our sales representatives.

Features

- In addition to maintaining the performance of the existing S-576Z B Series, the operation temperature range has been extended (-50°C to +150°C)
- Uses a thin (t0.80 mm max.) TSOT-23-3S package, allowing for device miniaturization
- · Contributes to reduction of mechanism operation dispersion through high accuracy detection of magnetic flux density (magnetic field) polarity changes
- · Contributes to device safe design with a built-in output current limit circuit

Specifications

Pole detection:	ZCL detection	 Infrastructure equipment
 Output logic^{*1}: 	Vout = "L" at S pole detection	 Outdoor brushless DC motor
	Vout = "H" at S pole detection	 Home appliance
 Output form^{*1}: 	Nch open-drain output	 Housing equipment
	Nch driver + built-in pull-up resistor (1.2 k Ω typ.)	 Industrial equipment
 Zero crossing latch point: 	Bz = 0.0 mT typ.	
 Release point (S pole)^{*1}: 	B _{RS} = 3.0 mT typ.	
	$B_{RS} = 6.0 \text{ mT typ.}$	
 Chopping frequency: 	$f_c = 500 \text{ kHz typ.}$	Package
Output delay time:	t _D = 8.0 μs typ.	C
 Power supply voltage range^{*2}: 	V _{DD} = 2.7 V to 26.0 V	• TSOT-23-3S
Built-in regulator		
Built-in output current limit circuit	t	

• Operation temperature range: $Ta = -50^{\circ}C to +150^{\circ}C$

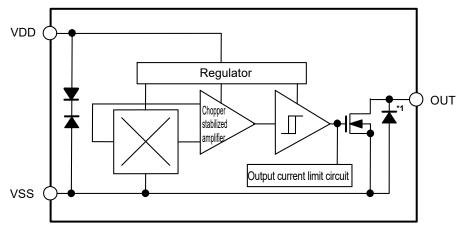
Lead-free (Sn 100%), halogen-free

*1. The option can be selected.

*2. V_{DD} = 2.7 V to 5.5 V when output form is Nch driver + built-in pull-up resistor (1.2 k Ω typ.)

Block Diagrams

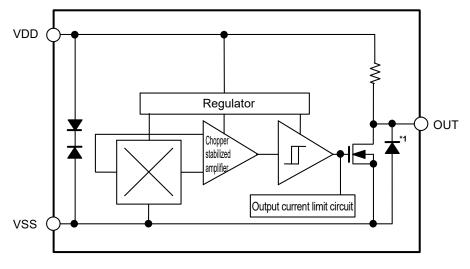
1. Nch open-drain output product



*1. Parasitic diode



2. Nch driver + built-in pull-up resistor product

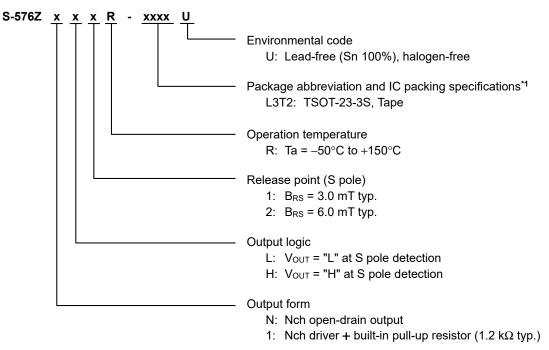


*1. Parasitic diode

Figure 2

Product Name Structure

1. Product name



*1. Refer to the tape drawing.

2. Package

 Table 1
 Package Drawing Codes

Package Name	Dimension	Таре	Reel
TSOT-23-3S	MP003-E-P-SD	MP003-E-C-SD	MP003-E-R-SD

3. Product name list

Table 2

Product Name	Output Form	Power Supply Voltage Range	Output Logic	Release point (S pole) (B _{RS})
S-576ZNL1R-L3T2U	Nch open-drain output	V _{DD} = 2.7 V to 26.0 V	V _{OUT} = "L" at S pole detection	3.0 mT typ.
S-576Z1L1R-L3T2U	Nch driver + built-in pull-up resistor (1.2 k Ω typ.)	V _{DD} = 2.7 V to 5.5 V	V _{OUT} = "L" at S pole detection	3.0 mT typ.

Remark Please contact our sales representatives for products other than the above.

Pin Configuration

1. TSOT-23-3S

Top view



Table 3							
Pin No.	Symbol	Description					
1	VSS	GND pin					
2	VDD	Power supply pin					
3	OUT	Output pin					

Figure 3

Absolute Maximum Ratings

Table 4

Item			Absolute Maximum Rating	Unit
	Nch open-drain output product		$V_{SS} - 0.3$ to $V_{SS} + 28.0$	V
Power supply voltage	Nch driver + built-in pull-up resistor (1.2 kΩ typ.) product	Vdd	$V_{\text{SS}} - 0.3$ to $V_{\text{SS}} + 9.0$	V
Power supply current		IDD	±10	mA
Output current		Іоит	±10	mA
	Nch open-drain output product		$V_{\text{SS}}-0.3$ to $V_{\text{SS}}+28.0$	V
Output voltage	Nch driver + built-in pull-up resistor (1.2 kΩ typ.) product	Vout	$V_{\text{SS}} - 0.3$ to $V_{\text{DD}} + 0.3$	V
Operation ambient temperature		T _{opr}	–50 to +150	°C
Storage temperature		T _{stg}	-50 to +170	°C

Caution The absolute maximum ratings are rated values exceeding which the product could suffer physical damage. These values must therefore not be exceeded under any conditions.

■ Thermal Resistance Value

Table 5

Item	Symbol	Condition		Min.	Тур.	Max.	Unit
	ALθ		Board A	-	225	-	°C/W
			Board B	-	190	-	°C/W
Junction-to-ambient thermal resistance*1		TSOT-23-3S	Board C	-	_	-	°C/W
			Board D	-	_	-	°C/W
			Board E	_	_	-	°C/W

*1. Test environment: compliance with JEDEC STANDARD JESD51-2A

Remark Refer to "■ **Power Dissipation**" and "**Test Board**" for details.

Electrical Characteristics

1. Nch open-drain output product

Table 6

(Ta = $+25^{\circ}$ C, V _{DD} = 12.0 V, V _{SS} = 0 V unless otherwise specifi							
Item	Symbol	Condition	Min.	Тур.	Max.	Unit	Test Circuit
Power supply voltage	V _{DD}	_	2.7	12.0	26.0	V	-
Current consumption	I _{DD}	_	_	4.0	4.5	mA	1
Low level output voltage	Vol	Ιουτ = 5 mA, Vουτ = "L"	-	-	0.4	V	2
Leakage current	ILEAK	V _{OUT} = "H"	-	-	1.0	μA	3
Output limit current	Іом	V _{OUT} = 12.0 V	11	-	35	mA	3
Output delay time*1	t _D	—	-	8	16	μs	_
Chopping frequency*1	fc	—	250	500	_	kHz	—
Start up time*1	tPON	_	-	25	40	μs	4
Output rise time*1	t _R	C = 20 pF, R = 820 Ω	_	_	1.0	μs	5
Output fall time*1	tF	C = 20 pF, R = 820 Ω	_	_	1.0	μs	5

***1.** This item is guaranteed by design.

2. Nch driver + built-in pull-up resistor (1.2 k Ω typ.) product

Table 7

(Ta = +25°C, V_{DD} = 5.0 V, V_{SS} = 0 V unless otherwise specified)

Item	Symbol	Condition	Min.	Тур.	Max.	Unit	Test Circuit
Power supply voltage	Vdd	_	2.7	5.0	5.5	V	-
Current consumption	IDD	V _{OUT} = "H"	-	4.0	4.5	mA	1
Low level output voltage	Vol	Ιουτ = 0 mA, Vουτ = "L"	-	-	0.4	V	2
High level output voltage	V _{OH}	I _{OUT} = 0 mA, V _{OUT} = "H"	$V_{\text{DD}} \times 0.9$	-	-	V	2
Output limit current	Іом	$V_{DD} = V_{OUT} = 5.0 V$	11	-	35	mA	3
Output delay time*1	t _D	_	_	8	16	μs	_
Chopping frequency*1	fc	_	250	500	-	kHz	_
Start up time*1	t _{PON}	_	-	25	40	μs	4
Output rise time*1	t _R	C = 20 pF	_	I	1.0	μs	5
Output fall time*1	t _F	C = 20 pF	_	_	1.0	μs	5
Pull-up resistor	R∟	_	0.9	1.2	1.5	kΩ	_

*1. This item is guaranteed by design.

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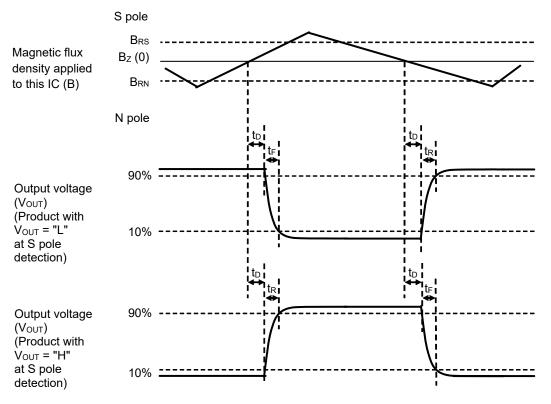


Figure 4 Operation Timing

Magnetic Characteristics

1. Product with $B_{RS} = 3.0 \text{ mT}$ typ.

Table 8

			(Ta = +25	°C, V _{DD} = {	5.0 V, Vss -	= 0 V unles	s otherv	vise specified)
Item		Symbol	Condition	Min.	Тур.	Max.	Unit	Test Circuit
Zero crossing latch point		Bz*1	_	-1.15	0.0	1.15	mT	4
Delessensint	S pole	B _{RS} *2	-	1.9	3.0	4.1	mT	4
Release point	N pole	B _{RN} *3	_	-4.1	-3.0	-1.9	mT	4

2. Product with $B_{RS} = 6.0 \text{ mT}$ typ.

Table 9

			(Ta = +25	°C, V _{DD} =	5.0 V, Vss :	= 0 V unles	ss otherv	vise specified)
Item		Symbol	Condition	Min.	Тур.	Max.	Unit	Test Circuit
Zero crossing latch po	oint	Bz*1	_	-1.35	0.0	1.35	mT	4
Delesses weight	S pole	B _{RS} *2	_	4.0	6.0	8.0	mT	4
Release point	N pole	B _{RN} *3	-	-8.0	-6.0	-4.0	mT	4

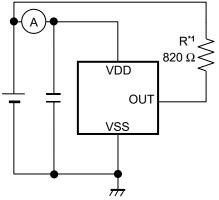
 *1. B_Z: Zero crossing latch point B_Z is the value of magnetic flux density at which polarity changes are detected according to the magnetic flux density applied to this IC.

 *2. B_{RS}: Release point (S pole) B_{RS} is the value of magnetic flux density of release point (S pole). This IC releases the Hold status of the output voltage (V_{OUT}) when the magnetic flux density applied to this IC exceeds B_{RS} (by moving the magnet (S pole) closer).

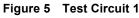
*3. B_{RN}: Release point (N pole) B_{RN} is the value of magnetic flux density of release point (N pole). This IC releases the Hold status of the output voltage (V_{OUT}) when the magnetic flux density applied to this IC exceeds B_{RN} (by moving the magnet (N pole) closer).

Remark The unit of magnetic density mT can be converted by using the formula 1 mT = 10 Gauss.

Test Circuits



*1. Resistor (R) is unnecessary for Nch driver + built-in pull-up resistor product.



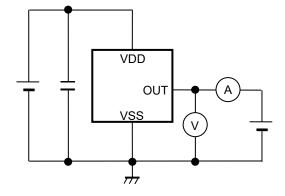
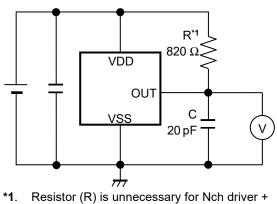


Figure 7 Test Circuit 3



built-in pull-up resistor product.



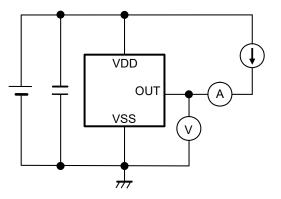
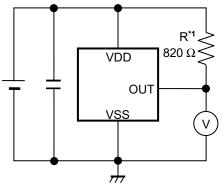


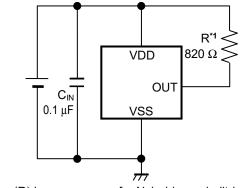
Figure 6 Test Circuit 2



*1. Resistor (R) is unnecessary for Nch driver + built-in pull-up resistor product.

Figure 8 Test Circuit 4

Standard Circuit



*1. Resistor (R) is unnecessary for Nch driver + built-in pull-up resistor product.

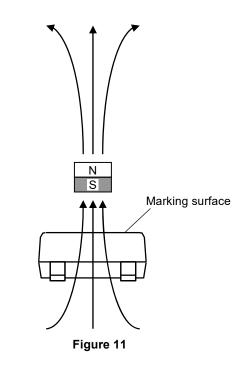
Figure 10

Caution The above connection diagram and constants will not guarantee successful operation. Perform thorough evaluation using the actual application to set the constants.

Operation

1. Direction of applied magnetic flux

This IC detects the magnetic flux density which is perpendicular to the package marking surface. A magnetic field is defined as positive when marking side of the package is the S pole, and negative when it is the N pole. **Figure 11** shows polarity in a magnetic field and direction in which magnetic flux is being applied.



2. Position of Hall sensor

Figure 12 shows the position of Hall sensor.

The center of this Hall sensor is located in the area indicated by a circle, which is in the center of a package as described below.

The following also shows the distance (typ. value) between the marking surface and the chip surface of a package.

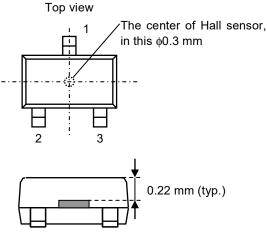


Figure 12

3. Basic operation

This IC switches output voltage level (V_{OUT}) when the IC detects magnetic flux density (magnetic field) polarity changes by using ZCL technology. ZCL technology realizes polarity changes detection and hold operation (Hold status) of V_{OUT} . This is different from the conventional bipolar latch method. ZCL detection method has no hysteresis width of the magnetic sensitivity to switch V_{OUT} . Instead, the ZCL detection method can switch V_{OUT} without chattering by using the Hold status.

3.1 ZCL basic operation

This IC switches V_{OUT} after the output delay time (t_D) from when the magnetic flux density applied to this IC crosses B_Z (from B > B_{RS} to B < B_Z or from B < B_{RN} to B > B_Z). When V_{OUT} is switched, this IC starts the Hold status. In the Hold status of V_{OUT}, when the magnetic flux density applied to this IC exceeds B_{RS} or B_{RN}, this IC releases the Hold status (from B < B_Z to B < B_{RN} or from B > B_Z to B > B_{RS}).

Figure 13 and Figure 14 show the V_{OUT} operation timing when sine wave magnetic flux density is applied to this IC.

- (1) $B > B_{RS} \rightarrow B < B_Z$, and after t_D, V_{OUT} = "L" \rightarrow "H", and Hold status starts
- (2) $B < B_Z \rightarrow B < B_{RN}$, and after t_D, Hold status is released, and V_{OUT} = "H" continues
- (3) $B < B_{RN} \rightarrow B > B_Z$, and after t_D, V_{OUT} = "H" \rightarrow "L", and Hold status starts
- (4) $B > B_Z \rightarrow B > B_{RS}$, and after t_D, Hold status is released, and V_{OUT} = "L" continues

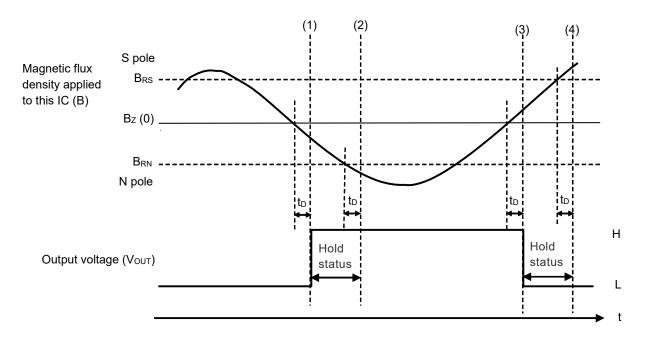


Figure 13 Product with VOUT = "L" at S pole detection

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- (1) $B > B_{RS} \rightarrow B < B_Z$, and after t_D, V_{OUT} = "H" \rightarrow "L", and Hold status starts
- (2) $B < B_Z \rightarrow B < B_{RN}$, and after t_D, Hold status is released, and V_{OUT} = "L" continues
- (3) $B < B_{RN} \rightarrow B > B_Z,$ and after $t_D,$ V_{OUT} = "L" \rightarrow "H", and Hold status starts
- (4) $B > B_Z \rightarrow B > B_{RS}$, and after t_D, Hold status is released, and V_{OUT} = "H" continues

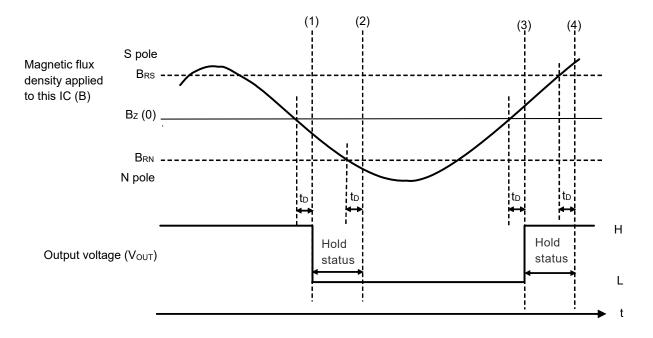


Figure 14 Product with VOUT = "H" at S pole detection

3. 2 Prevention of VOUT chattering by Hold status

By the Hold status, this IC can switch V_{OUT} without chattering even under an influence of external mechanical vibrations, electrical noise, or magnetic noise.

Figure 15 and **Figure 16** show the V_{OUT} operation when the magnetic flux density applied to this IC changes near the zero crossing latch point (B_z) and B_z is crossed multiple times.

(1) In the Hold status, the IC retains VOUT when the magnetic flux density applied to this IC crosses Bz.

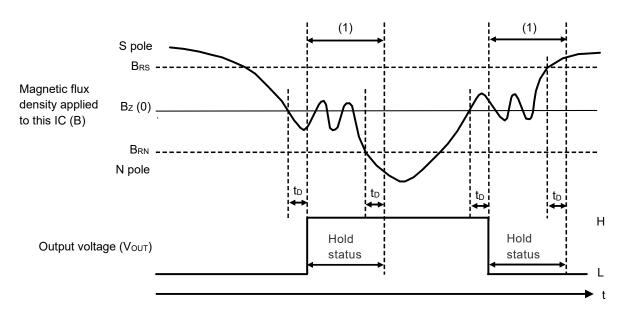


Figure 15 Product with VOUT = "L" at S pole detection

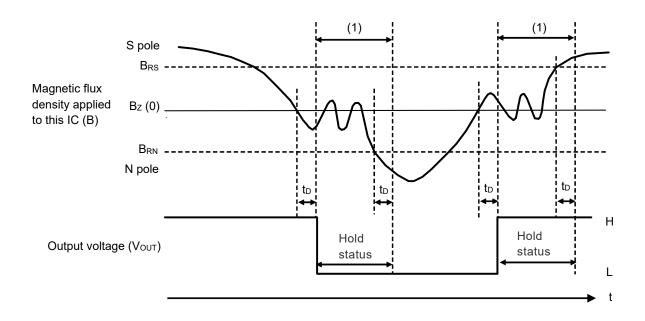


Figure 16 Product with V_{OUT} = "H" at S pole detection

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3.3 Operation when polarity changes direction is inverted in the Hold status

In the Hold status, when the polarity changes direction is inverted, this IC release the Hold status at the opposite release point and switches V_{OUT} .

Figure 17 and Figure 18 show the VOUT operation timing when the polarity change direction is inverted.

- (1) $B > B_Z \rightarrow B < B_Z$, and after t_D, V_{OUT} = "L" \rightarrow "H", and Hold status starts
- (2) During Hold status, even after $B < B_Z \rightarrow B > B_Z$, V_{OUT} = "H" is retained
- (3) $B > B_Z \rightarrow B > B_{RS}$, and after t_D, Hold status is released, and V_{OUT} = "H" \rightarrow "L"
- (4) $B < B_Z \rightarrow B > B_Z$, and after t_D, V_{OUT} = "H" \rightarrow "L", and Hold status starts
- (5) During Hold status, even after $B > B_Z \rightarrow B < B_Z$, $V_{OUT} = "L"$ is retained
- (6) $B < B_Z \rightarrow B < B_{RN}$, and after t_D, Hold status is released, and V_{OUT} = "L" \rightarrow "H"

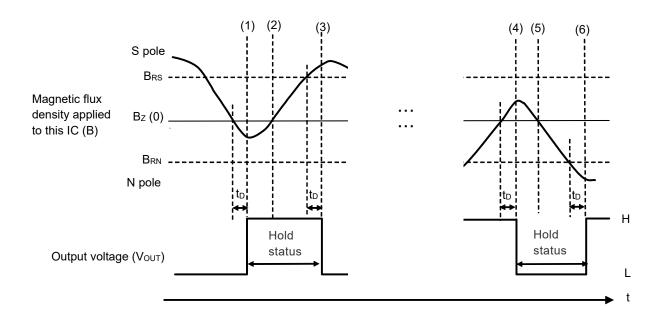


Figure 17 Product with VOUT = "L" at S pole detection

- (1) $B > B_Z \rightarrow B < B_Z,$ and after $t_D, \, V_{OUT}$ = "H" \rightarrow "L", and Hold status starts
- (2) During Hold status, even after $B < B_Z \rightarrow B > B_Z$, V_{OUT} = "L" is retained
- (3) $B > B_Z \rightarrow B > B_{RS},$ and after $t_D,$ Hold status is released, and V_{OUT} = "L" \rightarrow "H"
- (4) $B < B_Z \rightarrow B > B_Z$, and after t_D, V_{OUT} = "L" \rightarrow "H", and Hold status starts
- (5) During Hold status, even after $B > B_Z \rightarrow B < B_Z, V_{\text{OUT}}$ = "H" is retained
- (6) $B < B_Z \rightarrow B < B_{RN},$ and after $t_D,$ Hold status is released, and V_{OUT} = "H" \rightarrow "L"

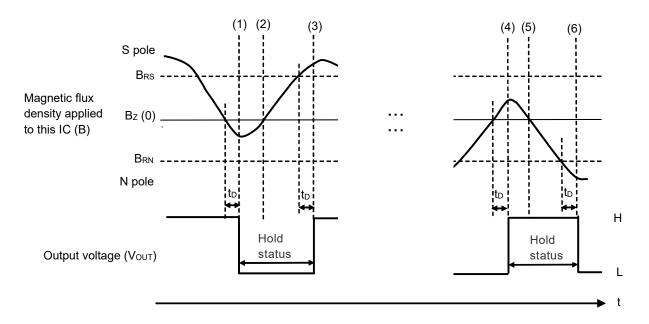


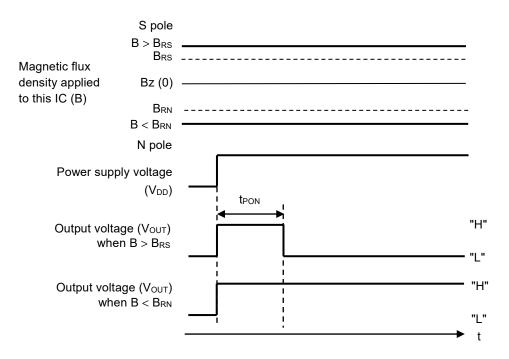
Figure 18 Product with V_{OUT} = "H" at S pole detection

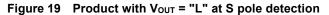
4. Power-on operation

This IC requires start up time (t_{PON}) during the time immediately after power-on until V_{OUT} switches. During the t_{PON} period, V_{OUT} is "H". After t_{PON}, when B > B_{RS} or B < B_{RN} is detected, polarity changes can be detected.

4.1 $B > B_{RS}$ or $B < B_{RN}$

When the magnetic flux density applied to this IC at power-on is $B > B_{RS}$ or $B < B_{RN}$, after t_{PON}, V_{OUT} switches according to the output logic at the S pole detection, and polarity changes can be detected. **Figure 19** and **Figure 20** show V_{OUT} operation immediately after power-on when $B > B_{RS}$ or $B < B_{RN}$.





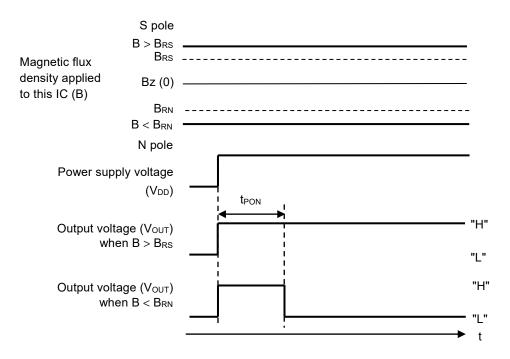
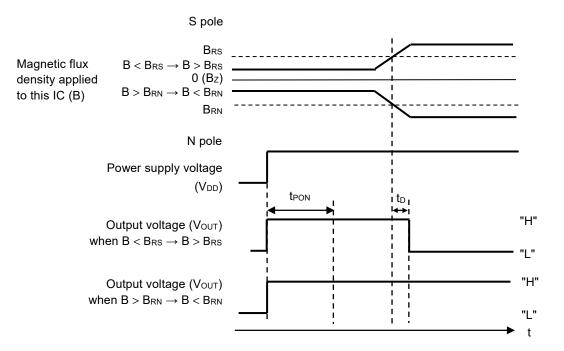
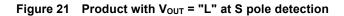


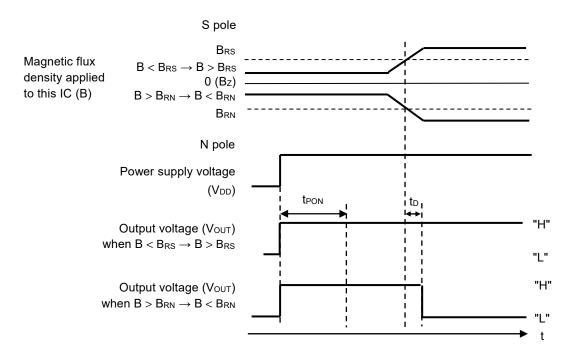
Figure 20 Product with V_{OUT} = "H" at S pole detection

4.2 B_{RN} < B < B_{RS}

When the magnetic flux density applied to this IC at power-on is $B_{RN} < B < B_{RS}$, after t_{PON} , V_{OUT} continues "H". Thereafter, when the magnetic flux density changes to $B > B_{RS}$ or $B < B_{RN}$, after t_D , V_{OUT} switches according to the output logic at the S pole detection and magnetic flux density, and polarity changes can be detected. **Figure 21** and **Figure 22** show V_{OUT} operation when change of $B_{RN} < B < B_{RS} \rightarrow B > B_{RS}$ or $B < B_{RN}$ occurs after t_{PON} .









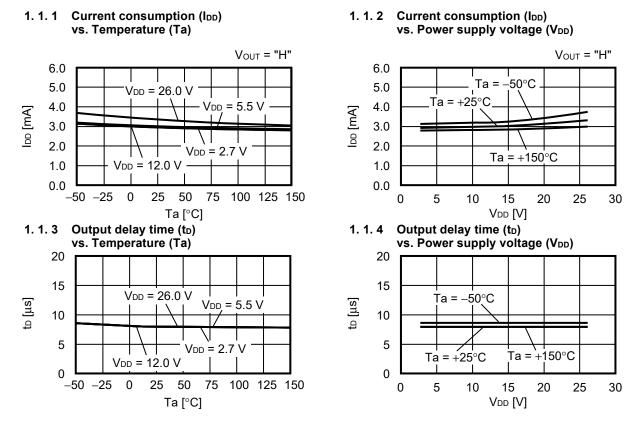
Precautions

- If the impedance of the power supply is high, the IC may malfunction due to a supply voltage drop caused by feed-through current. Take care with the pattern wiring to ensure that the impedance of the power supply is low.
- Note that the IC may malfunction if the power supply voltage rapidly changes. When the IC is used under the
 environment where the power supply voltage rapidly changes, it is recommended to judge the output voltage of
 the IC by reading it multiple times.
- Do not apply an electrostatic discharge to this IC that exceeds the performance ratings of the built-in electrostatic protection circuit.
- Although this IC has a built-in output current limit circuit, it may suffer physical damage such as product deterioration under the environment where the absolute maximum ratings are exceeded.
- The application conditions for the power supply voltage, the pull-up voltage, and the pull-up resistor should not exceed the power dissipation.
- Large stress on this IC may affect the magnetic characteristics. Avoid large stress which is caused by the handling during or after mounting the IC on a board.
- Since the package heat radiation differs according to the conditions of the application, perform thorough evaluation with actual applications to confirm no problems occur.
- ABLIC Inc. claims no responsibility for any disputes arising out of or in connection with any infringement by products including this IC of patents owned by a third party.

Characteristics (Typical Data)

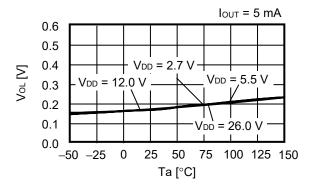
1. Electrical Characteristics

1.1 S-576ZxxxR

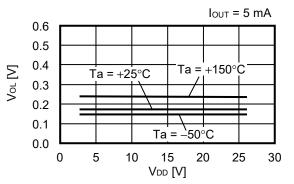


Caution $V_{DD} = 2.7 \text{ V}$ to 5.5 V when output form is Nch driver + built-in pull-up resistor (1.2 k Ω typ.). Comply with power supply voltage range and do not exceed absolute maximum ratings.

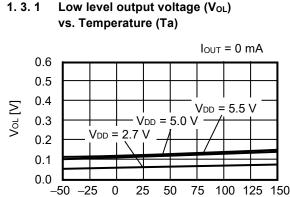
- 1.2 S-576ZNxxR
 - 1. 2. 1 Low level output voltage (V_{OL}) vs. Temperature (Ta)



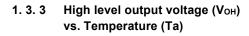
1.2.2 Low level output voltage (VoL) vs. Power supply voltage (VDD)

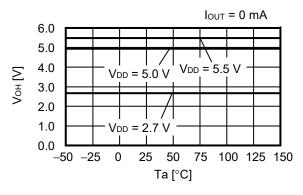


1.3 S-576Z1xxR

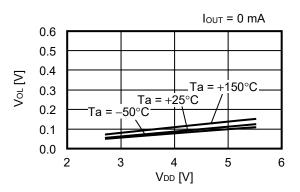


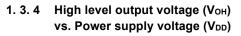


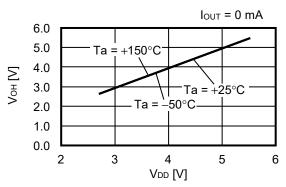




1.3.2 Low level output voltage (V_{OL}) vs. Power supply voltage (V_{DD})



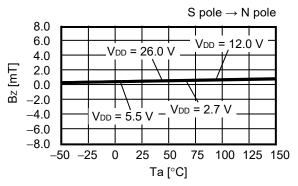


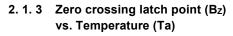


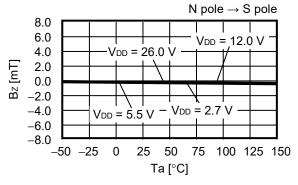
2. Magnetic Characteristics

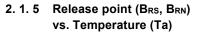
2.1 S-576Zxx1R

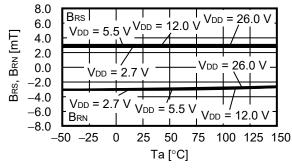
2. 1. 1 Zero crossing latch point (Bz) vs. Temperature (Ta)

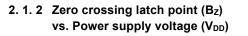


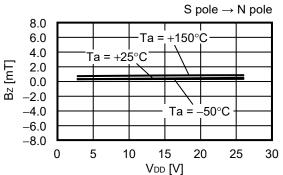


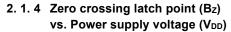


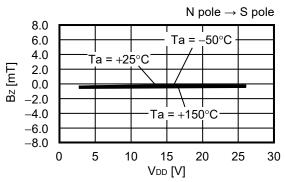


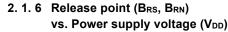


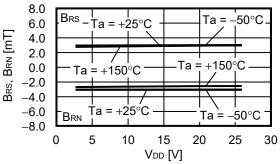






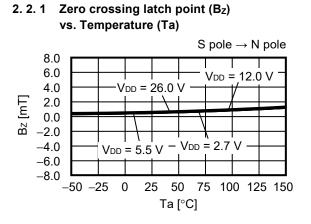


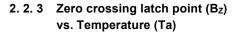


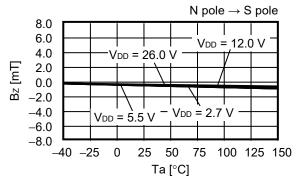


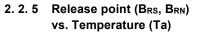
Caution $V_{DD} = 2.7 \text{ V}$ to 5.5 V when output form is Nch driver + built-in pull-up resistor (1.2 k Ω typ.). Comply with power supply voltage range and do not exceed absolute maximum ratings.

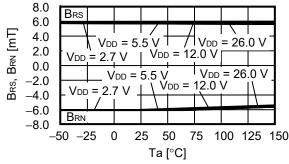
2.2 S-576Zxx2R

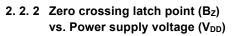


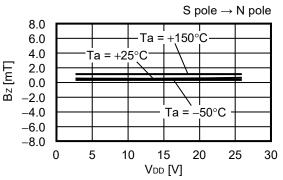


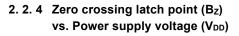


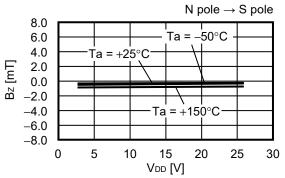


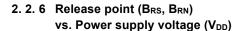


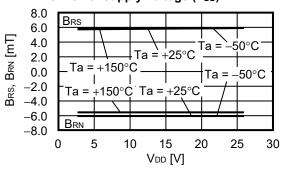








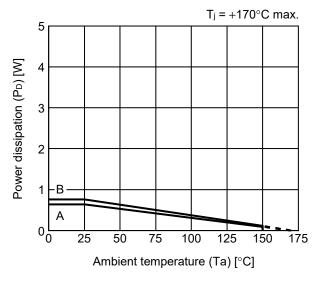




Caution $V_{DD} = 2.7$ V to 5.5 V when output form is Nch driver + built-in pull-up resistor (1.2 k Ω typ.). Comply with power supply voltage range and do not exceed absolute maximum ratings.

Power Dissipation

TSOT-23-3S



Board	Power Dissipation (P _D)
А	0.64 W
В	0.76 W
С	_
D	_
E	_

TSOT-23-3S Test Board

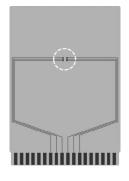
IC Mount Area

(1) Board A



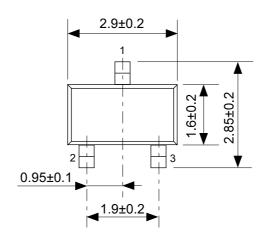
Item		Specification
Size [mm]		114.3 x 76.2 x t1.6
Material		FR-4
Number of copper foil layer		2
	1	Land pattern and wiring for testing: t0.070
Copper foil layer [mm]	2	-
	3	-
	4	74.2 x 74.2 x t0.070
Thermal via		-

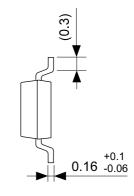
(2) Board B

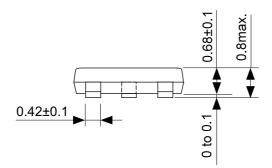


Item		Specification
Size [mm]		114.3 x 76.2 x t1.6
Material		FR-4
Number of copper foil layer		4
Copper foil layer [mm]	1	Land pattern and wiring for testing: t0.070
	2	74.2 x 74.2 x t0.035
	3	74.2 x 74.2 x t0.035
	4	74.2 x 74.2 x t0.070
Thermal via		-

No. TSOT23x-A-Board-SD-1.0

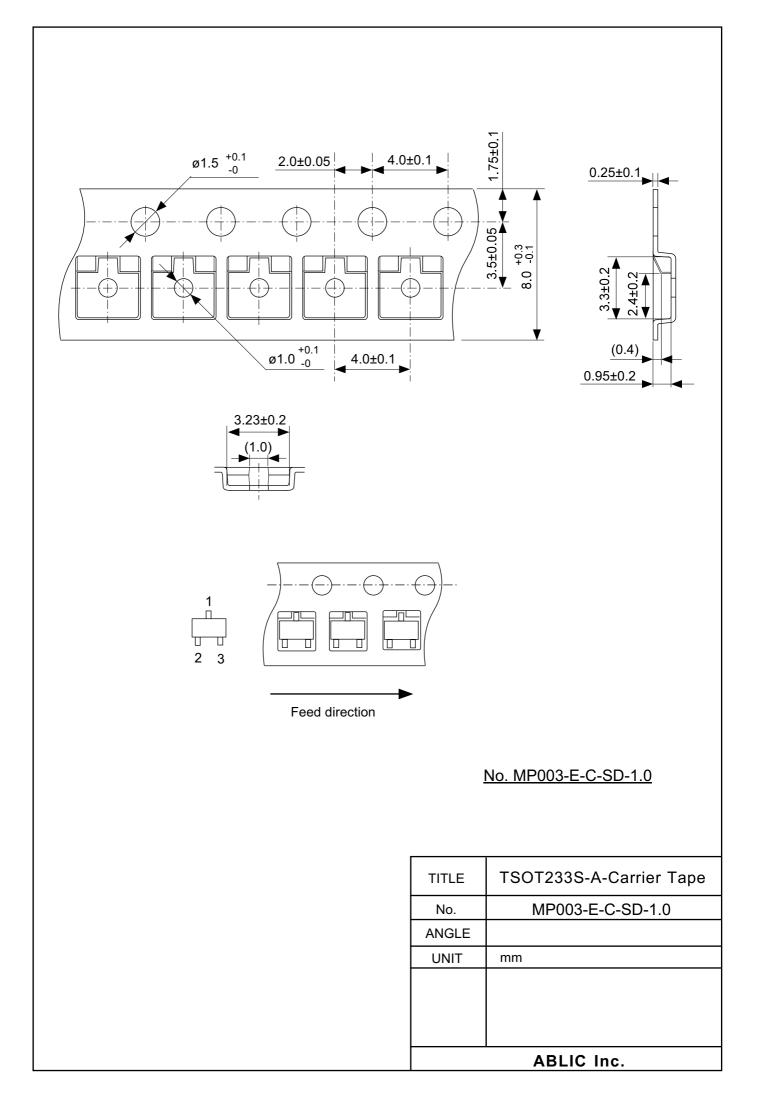


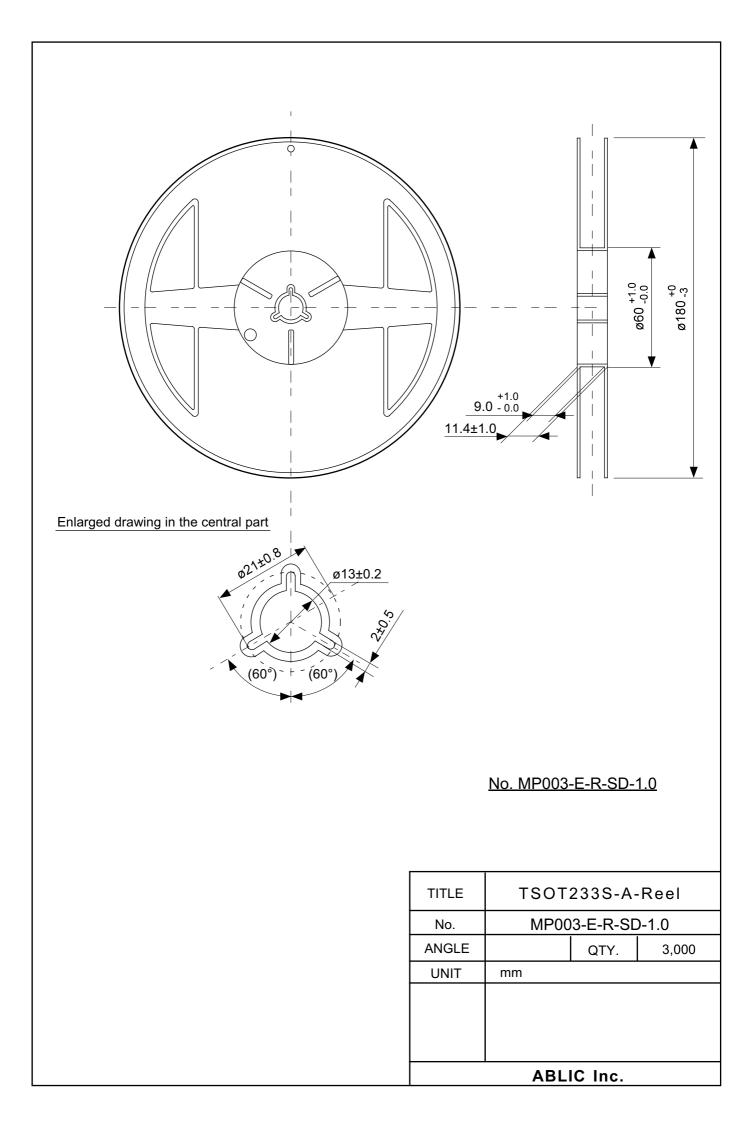




No. MP003-E-P-SD-1.0

TITLE	TSOT233S-A-PKG Dimensions	
No.	MP003-E-P-SD-1.0	
ANGLE	Φ	
UNIT	mm	
ABLIC Inc.		





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